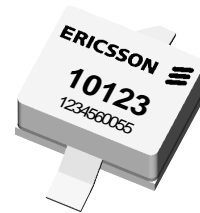
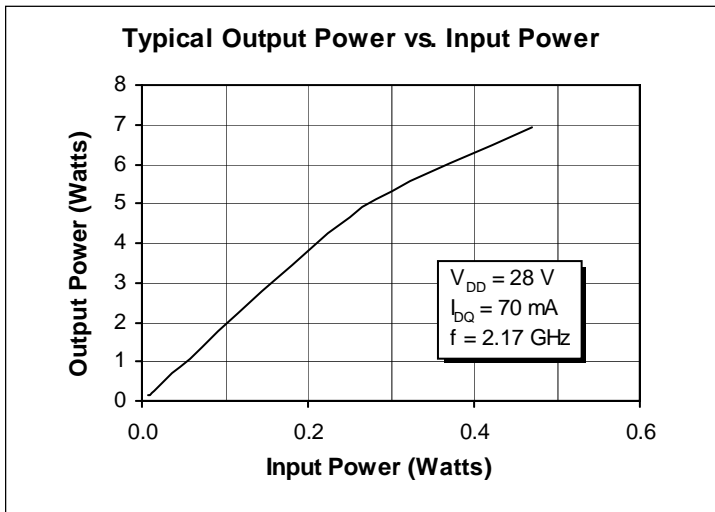


GOLDMOS[®] Field Effect Transistor 5 Watts, 2.1–2.2 GHz

Description

The 10123 is a GOLDMOS FET intended for large signal applications from 2.1 to 2.2 GHz. It operates with 47% efficiency and 11 db minimum gain. Nitride surface passivation and gold metallization ensure excellent device lifetime and reliability.

- **Guaranteed Performance at 2.17 GHz, 28 V**
- Output Power = 5 Watts Min
- Power Gain = 11 dB Min
- **Full Gold Metallization**
- **Silicon Nitride Passivated**
- **Back Side Common Source**
- **Excellent Thermal Stability**
- **100% Lot Traceability**



Package 20244

RF Specifications (100% Tested)

Characteristic	Symbol	Min	Typ	Max	Units
Gain ($V_{DD} = 28\text{ V}$, $P_{OUT} = 1\text{ W}$, $I_{DQ} = 70\text{ mA}$, $f = 2.11, 2.17\text{ GHz}$)	G_{ps}	11	—	—	dB
Power Output at 1 dB Compression ($V_{DD} = 28\text{ V}$, $I_{DQ} = 70\text{ mA}$, $f = 2.17\text{ GHz}$)	P-1dB	5	6.5	—	Watts
Drain Efficiency ($V_{DD} = 28\text{ V}$, $P_{OUT} = 5\text{ W}$, $I_{DQ} = 70\text{ mA}$, $f = 2.17\text{ GHz}$)	η_D	40	47	—	%
Load Mismatch Tolerance ($V_{DD} = 28\text{ V}$, $P_{OUT} = 5\text{ W}$, $I_{DQ} = 70\text{ mA}$, $f = 2.17\text{ GHz}$ —all phase angles at frequency of test)	Ψ	—	—	10:1	—

All published data at $T_{CASE} = 25^\circ\text{C}$ unless otherwise indicated.

* Note: Specifications for this product are preliminary and subject to change without notice. Please contact your sales representative for further product information. Complete product information is available on our Website at: www.ericsson.com/rfpower.

Electrical Characteristics (100% Tested)

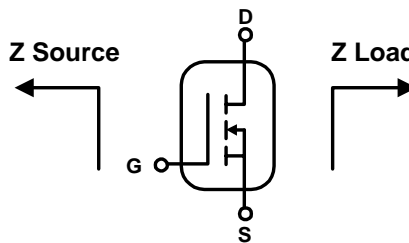
Characteristic	Conditions	Symbol	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 20\text{ mA}$	$V_{(BR)DSS}$	65	—	—	Volts
Zero Gate Voltage Drain Current	$V_{DS} = 26\text{ V}, V_{GS} = 0\text{ V}$	I_{DSS}	—	—	1.0	μA
Gate Threshold Voltage	$V_{DS} = 10\text{ V}, I_D = 75\text{ mA}$	$V_{GS(th)}$	3.0	—	5.0	Volts
Forward Transconductance	$V_{DS} = 10\text{ V}, I_D = 2\text{ A}$	g_{fs}	—	0.8	—	Siemens

Maximum Ratings

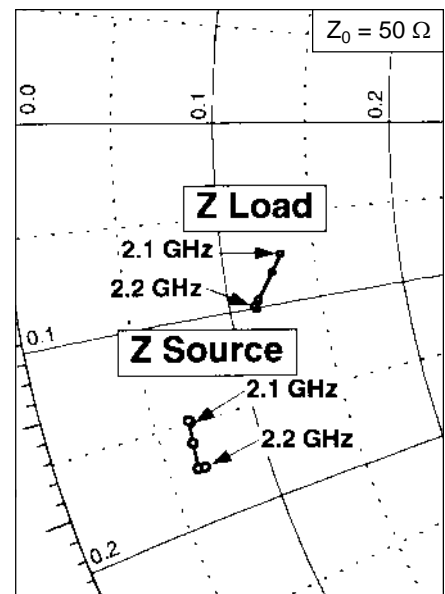
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	Vdc
Gate-Source Voltage	V_{GS}	± 20	Vdc
Operating Junction Temperature	T_J	200	$^{\circ}\text{C}$
Total Device Dissipation Above 25°C derate by	P_D	39 0.22	Watts $\text{W}/^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-40 to +150	$^{\circ}\text{C}$
Thermal Resistance ($T_{flange} = 70^{\circ}\text{C}$)	$R_{\theta JC}$	4.8	$^{\circ}\text{C}/\text{W}$

Impedance Data

$V_{DD} = 28\text{ V}, P_{OUT} = 5\text{ W}, I_{DQ} = 70\text{ mA}$

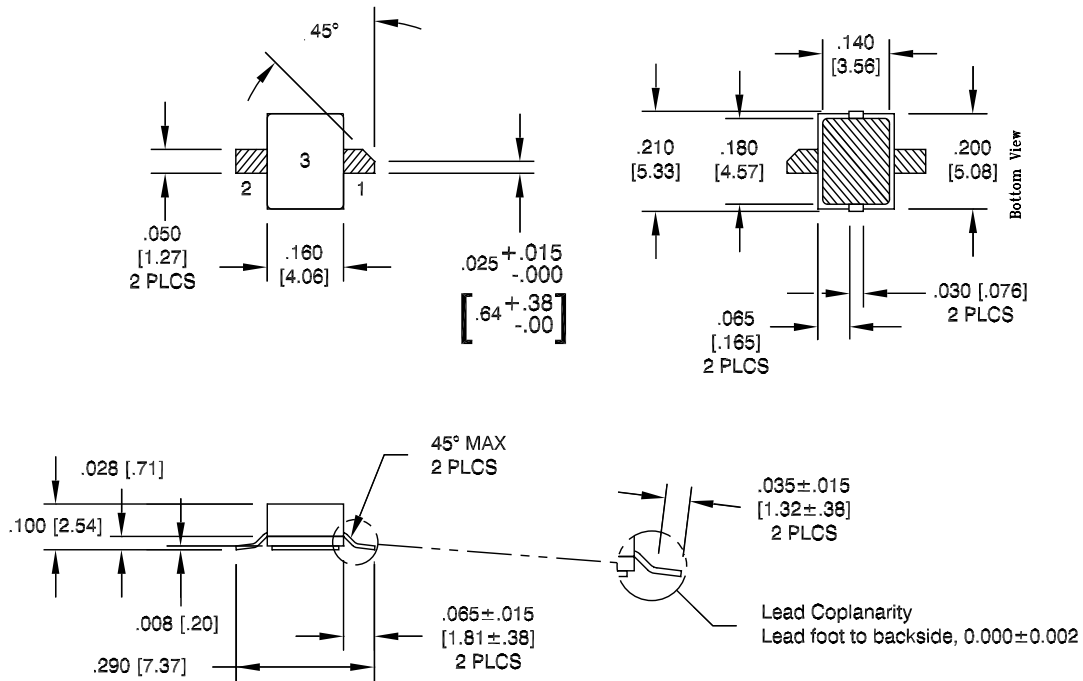


Frequency GHz	Z Source Ω		Z Load Ω	
	R	jX	R	jX
2.10	3.40	-7.48	6.60	-3.66
2.12	3.35	-7.44	6.30	-4.12
2.15	3.30	-8.00	5.82	-4.81
2.17	3.23	-8.64	5.72	-5.04
2.20	3.40	-8.67	5.69	-4.96



Case Outline Specifications

Case 20244



Unless otherwise specified
all tolerances ±.005" [0.13mm]

Pins: 1. Drain 2. Gate 3. Source
Lead Thickness: .008±.001" [0.20±0.03mm]